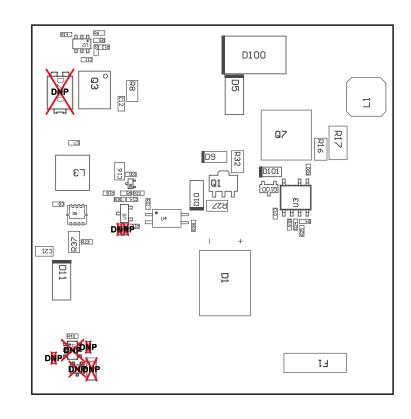


COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: PMP11451	REV: C	SUN REV:	: Not In VersionControl		
	TID #:					
PLOT NAME = Top Assembly Drawing	GENERATED : 12/28/	2015 9: 57: 44	AM	TEXAS INSTRUMENTS		



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED. ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP11451	REV: C	SUN REV:	Not In VersionControl	
	TID #:				
PLOT NAME = Bottom Assembly Drawing	GENERATED : 12/28/	² 2015 9: 57: 45	AM	TEXAS INSTRUMENTS	

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